



STGF100N30 STGP100N30, STGW100N30

90 A - 330 V - fast IGBT

Features

- Optimized for sustain and energy recovery circuits in PDP applications.
- State-of-the-art STripFET™ technology
- Peak collector current $I_{RP} = 330\text{ A}$ @ $T_C = 25\text{ °C}$ (see [Table 2](#))
- Very low-on voltage drop ($V_{CE(sat)}$) and energy per pulse for improved panel efficiency
- High repetitive peak current capability

Description

Advanced high-density and high-current IGBT technology with low-drop companion diode adapted to various functions in PDP sets.

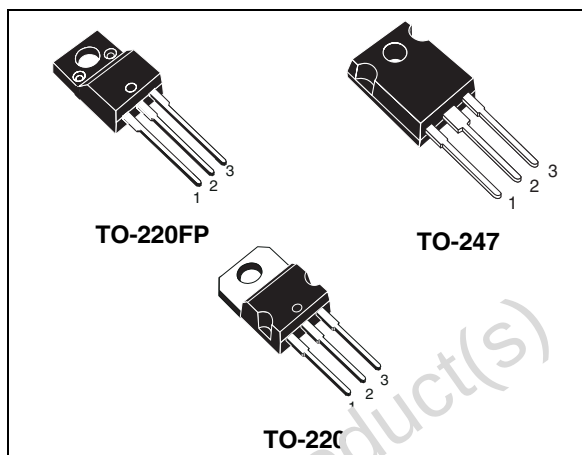


Figure 1. Internal schematic diagram

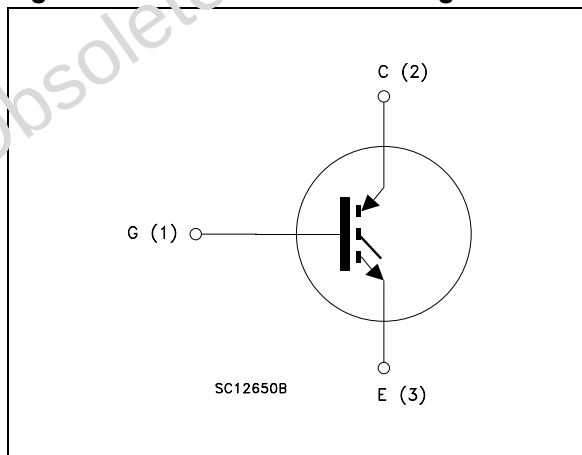


Table 1. Device summary

Order codes	Marking	Package	Packaging
STGF100N30	GF100N30	TO-220FP	Tube
STGP100N30	GP100N30	TO-220	Tube
STGW100N30	GW100N30	TO-247	Tube

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Obsolete Product(s) - Obsolete Product(s)

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value			Unit
		TO-220	TO-247	TO-220FP	
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$)	330			V
$I_C^{(1)}$	Collector current (continuous) at $T_C = 25\text{ °C}$	90		20	A
$I_C^{(1)}$	Collector current (continuous) at $T_C = 100\text{ °C}$	45		10	A
$I_{CL}^{(2)}$	Turn-off latching current	330			A
I_{RP}	Repetitive peak current at $T_C = 25\text{ °C}$	330 ⁽³⁾			A
V_{GE}	Gate-emitter voltage (continuous)	± 20			V
ESD (HBM)	Electrostatic sensitive discharge, human body model applied to all three pins ($C = 100\text{ pF}$, $R = 1.5\text{ k}\Omega$)	3			KV
ESD (MM)	Electrostatic sensitive discharge, machine model applied to all three pins ($C = 200\text{ pF}$, $R = 0$)	300			V
P_{TOT}	Total dissipation at $T_C = 25\text{ °C}$	250		40	W
T_j	Operating junction temperature	- 55 to 150			°C

1. Calculated according to the iterative formula:

$$I_C(T_C) = \frac{T_{j(max)} - T_C}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_C(T_C))}$$

2. $V_{clamp} = 300\text{ V}$, $T_j = 150\text{ °C}$, $R_G = 10\text{ }\Omega$, $V_{GE} = 15\text{ V}$

3. Half sine wave with duty cycle = 1%, $t_{on} > 1\text{ }\mu\text{s}$

Table 3. Thermal resistance

Symbol	Parameter	Value			Unit
		TO-220	TO-247	TO-220FP	
$R_{thj-case}$	Thermal resistance junction-case max	0.5			°C/W
$R_{thj-amb}$	Thermal resistance junction-ambient max	62.5	50	62.5	°C/W

2 Electrical characteristics

($T_{CASE} = 25\text{ °C}$ unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage ($V_{GE} = 0$)	$I_C = 1\text{ mA}$	330			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE} = 15\text{ V}$, $I_C = 50\text{ A}$ $V_{GE} = 15\text{ V}$, $I_C = 100\text{ A}$, $T_C = 125\text{ °C}$		1.9 2.6	2.5	V V
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = 10\text{ V}$, $I_C = 1\text{ mA}$	3.0		5.5	V
I_{CES}	Collector cut-off current ($V_{GE} = 0$)	$V_{CE} = 330\text{ V}$ $V_{CE} = 330\text{ V}$, $T_C = 125\text{ °C}$		1	3 200	μA μA
I_{GES}	Gate-emitter leakage current ($V_{CE} = 0$)	$V_{GE} = \pm 20\text{ V}$			± 1	μA

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
R_{ies}	Input resistance	$V_{CE} = 25\text{ V}$, $f = 1\text{ MHz}$, $V_{GE} = 0$		2		Ω
C_{ies}	Input capacitance			3550		pF
C_{oes}	Output capacitance			35		pF
C_{res}	Reverse transfer capacitance			335		pF

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
t_{rise}	Turn-off voltage rise time	$V_{GE} = 15\text{ V}$, $I_C = 25\text{ A}$, $V_{CC} = 180\text{ V}$ $R_G = 10\text{ }\Omega$, $L = 25\text{ }\mu\text{H}$,		25		ns
t_{doff}	Turn-off delay time			134		ns
t_{fall}	Turn-off current fall time			57		ns
t_{rise}	Turn-on voltage rise time	$V_{GE} = 15\text{ V}$, $I_C = 25\text{ A}$, $V_{CC} = 180\text{ V}$ $R_G = 10\text{ }\Omega$, $L = 25\text{ }\mu\text{H}$, $T_C = 150\text{ °C}$		60		ns
t_{doff}	Turn-on delay time			200		ns
t_{fall}	Turn-on current fall time			110		ns
E/p	Energy per pulse	$V_{CC} = 240\text{ V}$, $V_{GE} = 15\text{ V}$, $R_G = 5.1\text{ }\Omega$, $L = 250\text{ nH}$ $C = 0.40\text{ }\mu\text{F}$ (see Figure 15)		490		μJ

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

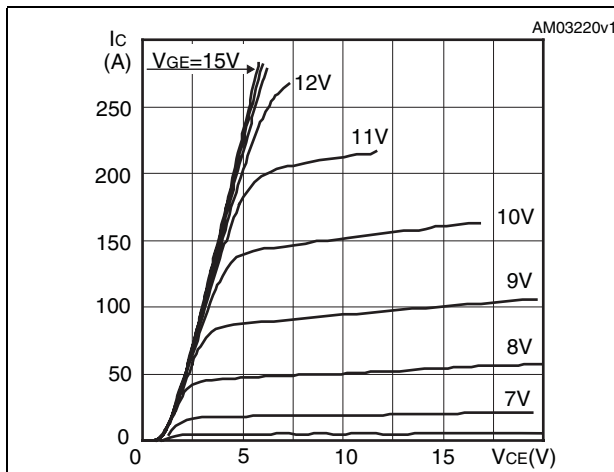


Figure 3. Transfer characteristics

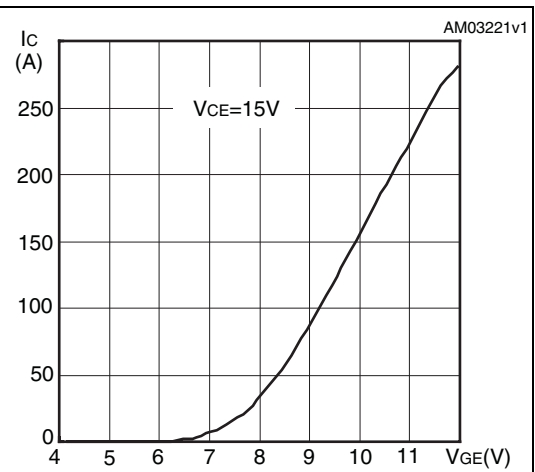


Figure 4. Transconductance

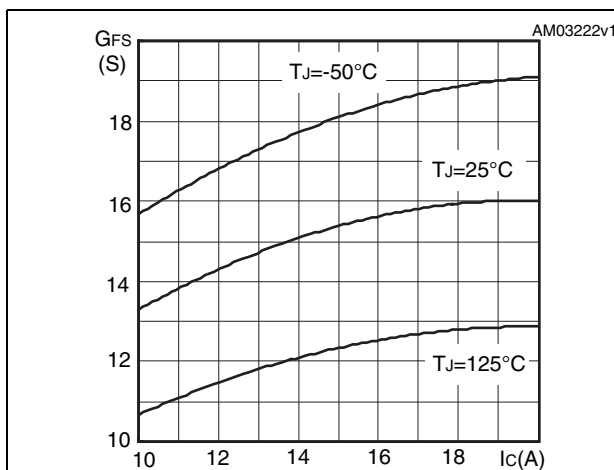


Figure 5. Collector-emitter on voltage vs. temperature

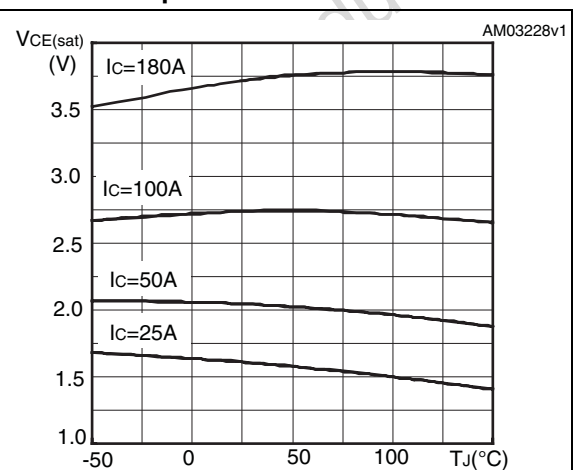


Figure 6. Gate charge vs. gate-source voltage

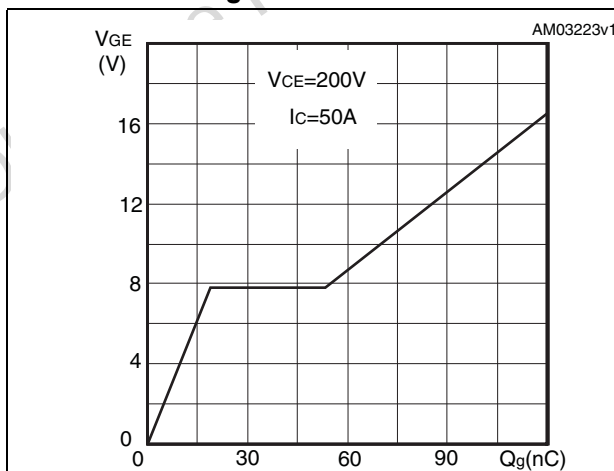


Figure 7. Capacitance variations

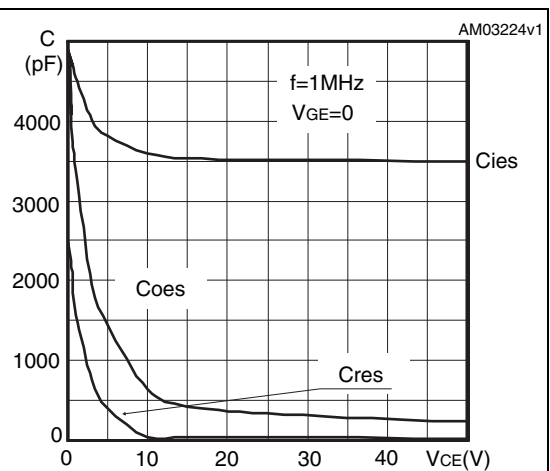


Figure 8. Normalized gate threshold voltage vs. temperature

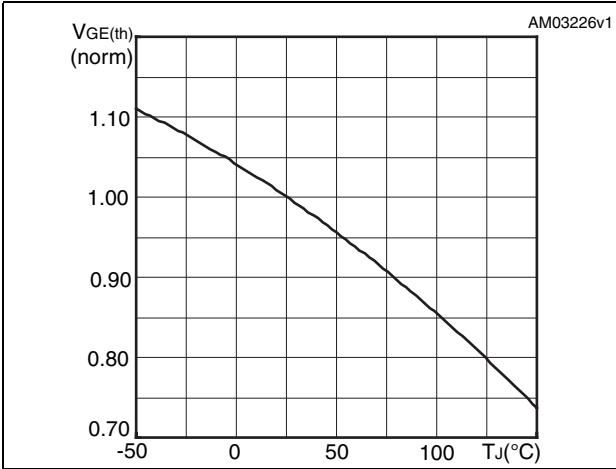


Figure 9. Collector-emitter on voltage vs. collector current

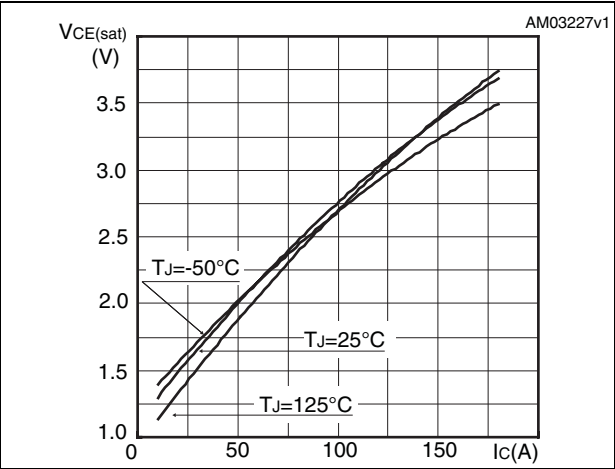


Figure 10. Normalized breakdown voltage vs. temperature

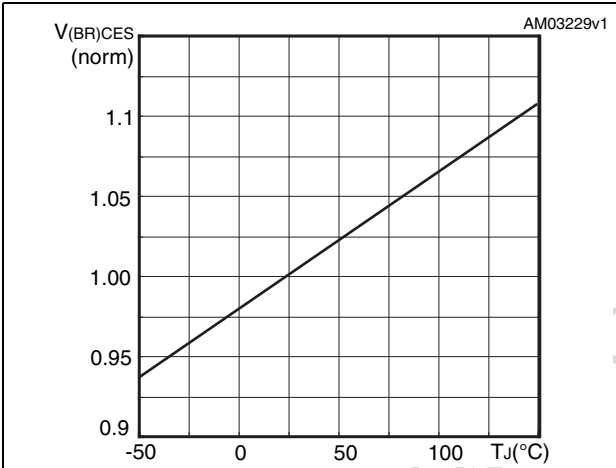
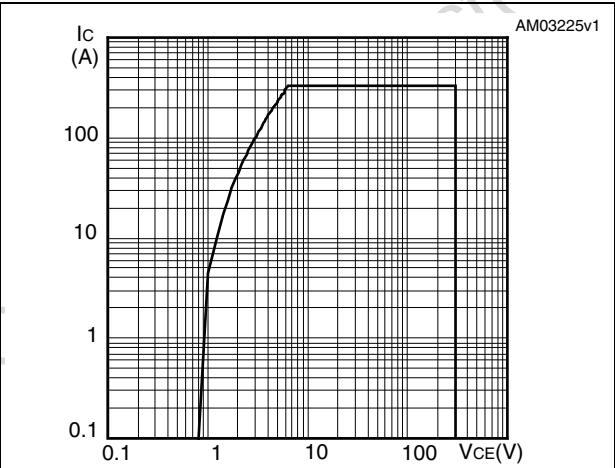


Figure 11. Turn-off SOA



3 Test circuits

Figure 12. Test circuit for inductive load switching

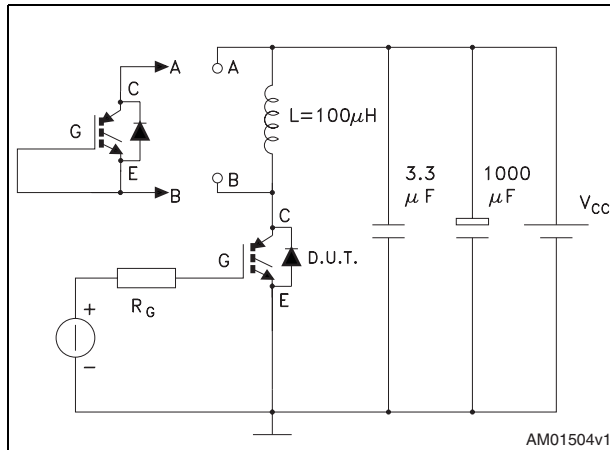


Figure 13. Gate charge test circuit

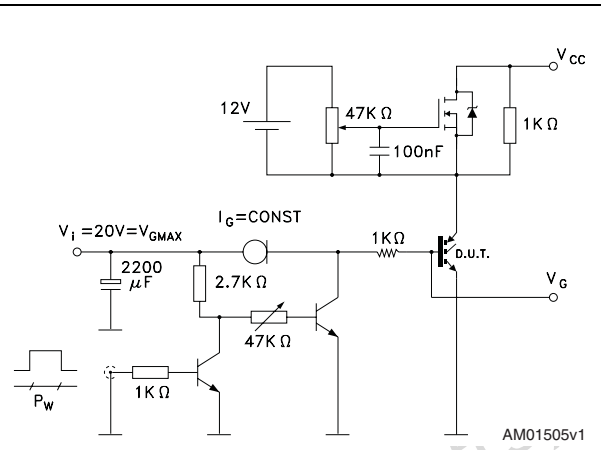


Figure 14. Switching waveforms

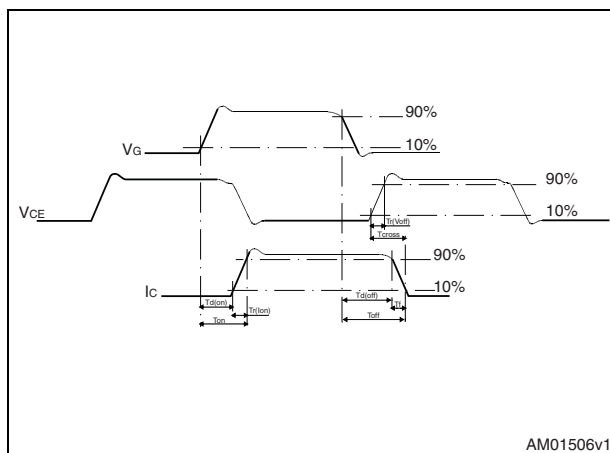
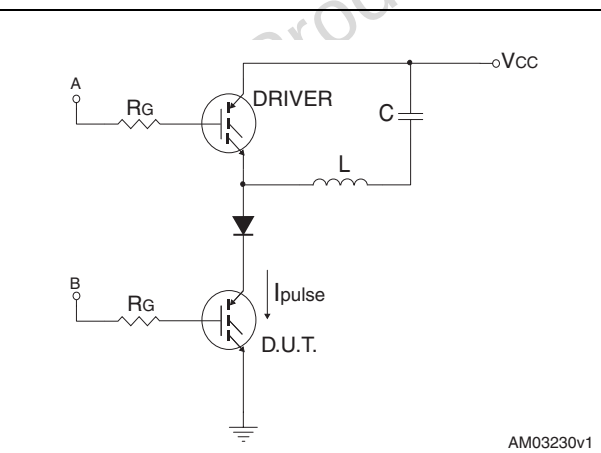


Figure 15. Energy per pulse test circuit



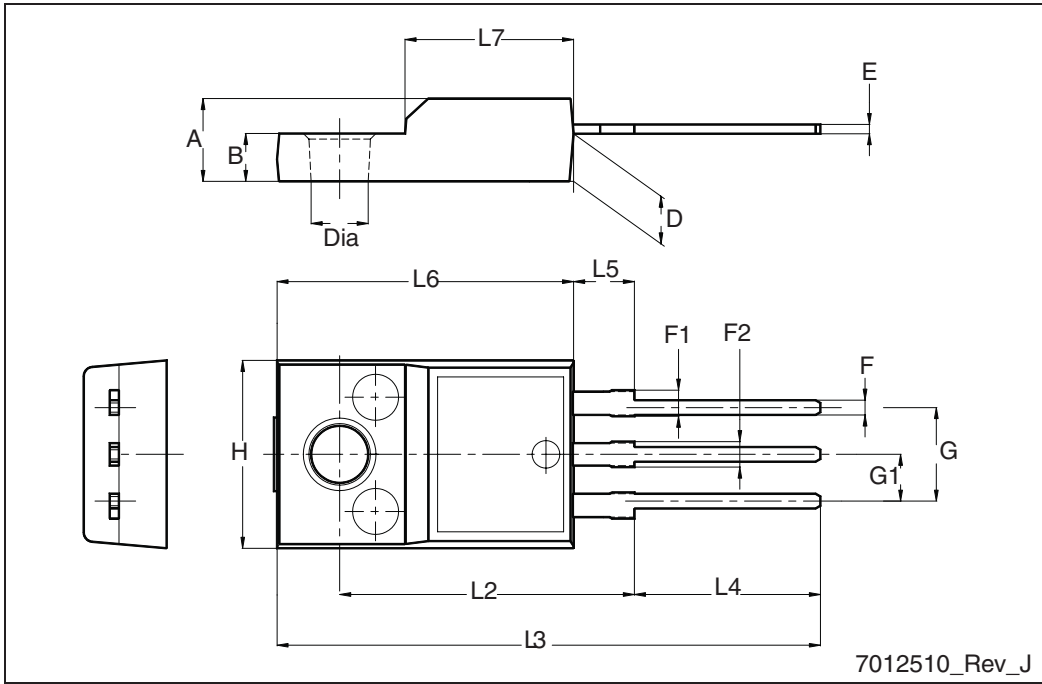
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Obsolete Product(s) - Obsolete Product(s)

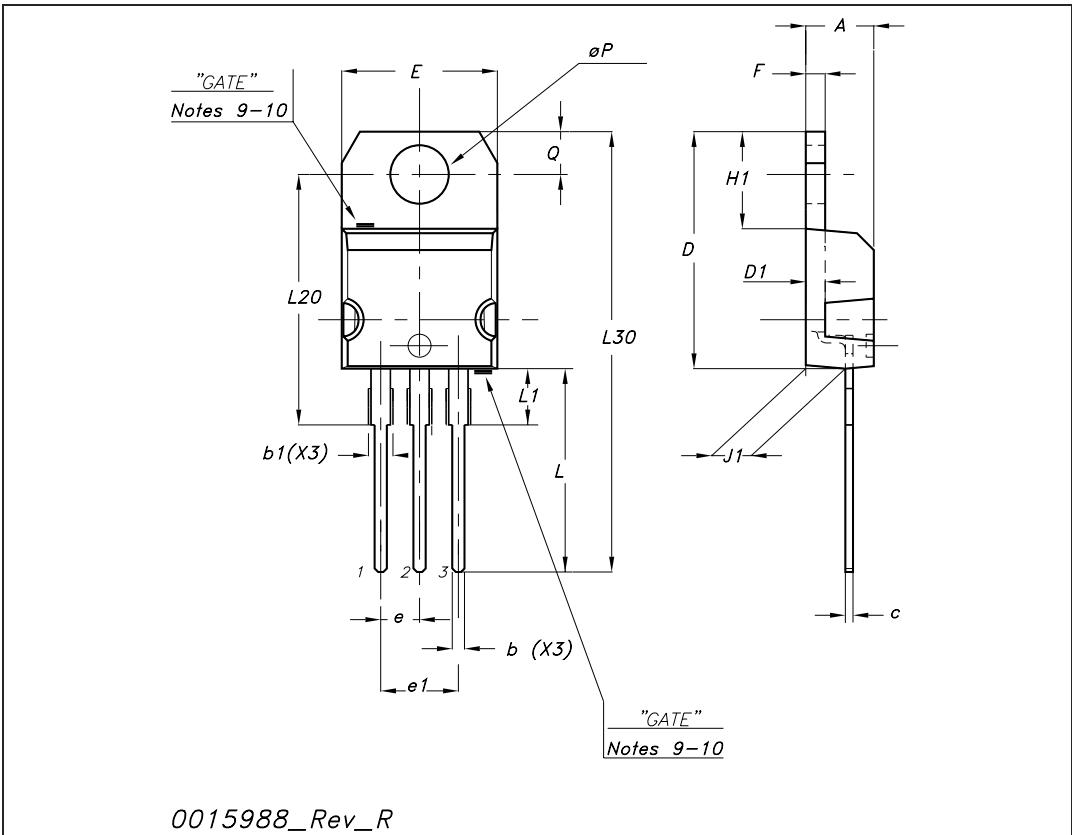
TO-220FP mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.4		4.6
B	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.5
G	4.95		5.2
G1	2.4		2.7
H	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2



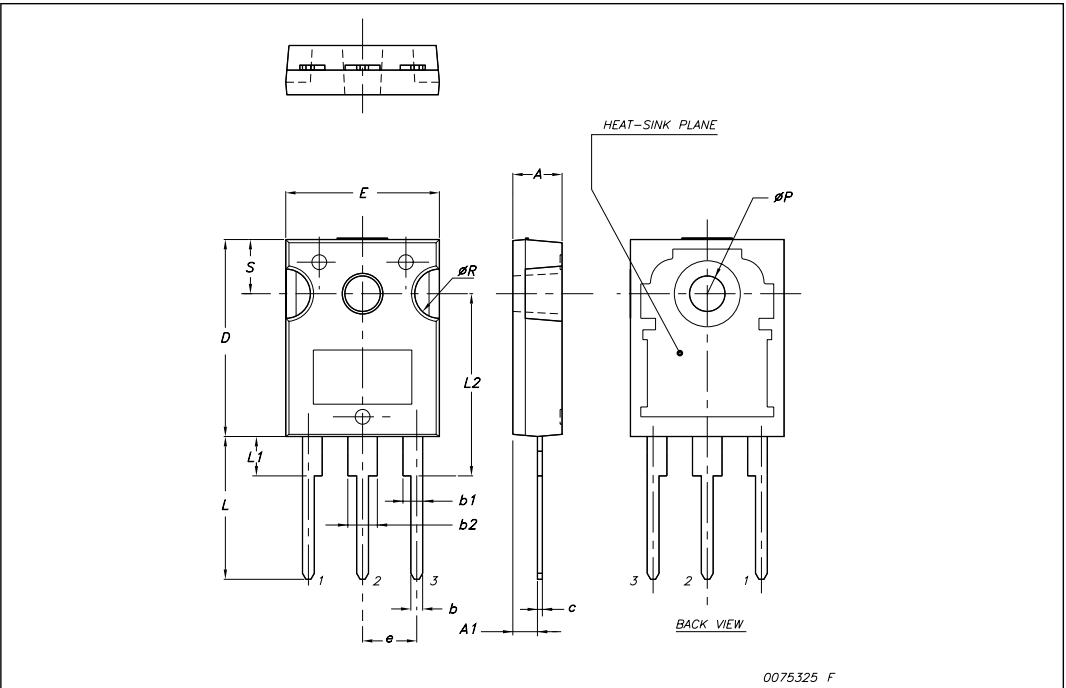
TO-220 mechanical data

Dim	mm			inch		
	Min	Typ	Max	Min	Typ	Max
A	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
c	0.48		0.70	0.019		0.027
D	15.25		15.75	0.6		0.62
D1		1.27			0.050	
E	10		10.40	0.393		0.409
e	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.051
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
ØP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



TO-247 Mechanical data

Dim.	mm.		
	Min.	Typ	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
øP	3.55		3.65
øR	4.50		5.50
S		5.50	



5 Revision history

Table 7. Document revision history

Date	Revision	Changes
11-Feb-2009	1	Initial release.

Obsolete Product(s) - Obsolete Product(s)

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